### Power Drivers for Peltier TEC Modules

### **Absolute Maximum Ratings**

| V <sub>DD</sub> to GND                                    | 0.3V to +6V                      |
|---|----------------------------------|
| SHDN, MAXV, MAXIP, MAXIN, CTLI,                           |                                  |
| FREQ to GND   | 0.3V to +6V                      |
| COMP, OS1, OS2, CS, REF,                                  |                                  |
| ITEC to GND   |                                  |
| PV <sub>DD</sub> 1, PV <sub>DD</sub> 2 to GND             | 0.3V to (V <sub>DD</sub> + 0.3V) |
| PV <sub>DD</sub> 1, PV <sub>DD</sub> 2 to V <sub>DD</sub> | -0.3V to +0.3V                   |
| PGND1, PGND2 to GND                                       | 0.3V to +0.3V                    |
| COMP, REF, ITEC Short to GND                              | Indefinite                       |

| Peak LX Current (MAX1968) (Note 1)                    | ±4.5A      |
|---|------------|
| Peak LX Current (MAX1969) (Note 1)                    |            |
| Continuous Power Dissipation (T <sub>A</sub> = +70°C) |            |
| 28-Pin TSSOP-EP (derate 23.8mW/°C above +70°C         | C)1.9W     |
| Operating Temperature Range40°C                       | C to +85°C |
| Maximum Junction Temperature                          | +150°C     |
| Storage Temperature Range65°C                         | to +150°C  |
| Lead Temperature (soldering 10s)                      | +300°C     |
|   |            |

**Note 1:** LX has internal clamp diodes to PGND and PV<sub>DD</sub>. Applications that forward bias these diodes should take care not to exceed the IC's package power dissipation limits.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **Electrical Characteristics**

 $(V_{DD} = PV_{DD}1 = PV_{DD}2 = \overline{SHDN} = 5V, PGND1 = PGND2 = FREQ = GND, CTLI = MAXV = MAXIP = MAXIN = REF, C_{REF} = 1\mu F, C_{COMP} = 0.1\mu F, L_{LX} = 3.3\mu H, C_{CS} = C_{OS2} = 1\mu F, I_{TEC} < 3A_{RMS} (MAX1968), I_{TEC} < 6A_{RMS} (MAX1969), T_{A} = 0^{\circ}C to +85^{\circ}C, unless otherwise noted. Typical values are at T_{A} = +25^{\circ}C.)$ 

| PARAMETER                     | SYMBOL                                     | CONDITIONS  |   | MIN          | TYP   | MAX   | UNITS |
|-------------------------------|--|---|---|--------------|-------|-------|-------|
| Input Supply Range            | $V_{DD}$                                   |   |   | 3.0          |       | 5.5   | V     |
|                               |  | $V_{DD} = 5V$ , $I_{TEC} = 0$ to ±3A,<br>$V_{OUT} = V_{OS1} - V_{OS2}$ (MAX1968)                    |   | -4.3         |       | +4.3  |       |
| Output Voltage Dange          | V 0 1 1 7                                  | V <sub>DD</sub> = 5V, I <sub>TEC</sub> = 0<br>V <sub>OUT</sub> = V <sub>OS1</sub> (MAX              |   |              |       | 4.3   | V     |
| Output Voltage Range          | Vout                                       | V <sub>DD</sub> = 3V, I <sub>TEC</sub> = 0<br>V <sub>OUT</sub> = V <sub>OS1</sub> - V <sub>OS</sub> | ,   | -2.3         |       | +2.3  | V     |
|                               |  | V <sub>DD</sub> = 3V, I <sub>TEC</sub> = 0<br>V <sub>OUT</sub> = V <sub>OS1</sub> (MAX              |   |              |       | 2.3   |       |
| Maximum TEC                   | lTEO(MAN)                                  | MAX1968   |   |              |       | ±3    | Α     |
| Current                       | ITEC(MAX)                                  | MAX1969   |   |              |       | 6     | A     |
| Reference Voltage             | V <sub>REF</sub>                           | $V_{DD} = 3V \text{ to } 5.5V, I_{REF} = 150\mu\text{A}$  |   | 1.485        | 1.500 | 1.515 | V     |
| Reference Load<br>Regulation  | $\Delta V_{REF}$                           | $V_{DD} = 3V \text{ to } 5.5V, I$   | REF = $+10\mu$ A to $-1$ mA               |              | 1.2   | 5     | mV    |
|                               |  | \/\\\   | V <sub>MAXI</sub> _ = V <sub>REF</sub>    | 140          | 150   | 160   |       |
| Current-Sense                 | VOS-                                       | Vos1 < Vcs  | V <sub>MAXI</sub> _ = V <sub>REF</sub> /3 | 40           | 50    | 60    | mV    |
| Threshold Accuracy            |  | V <sub>MAXI</sub> = V <sub>REF</sub> 140 150  | 160                                       | ] mv         |       |       |       |
|                               |  | Vos1 > Vcs  | V <sub>MAXI</sub> _ = V <sub>REF</sub> /3 | 40           | 50    | 60    |       |
| Switch-Fault Reset<br>Voltage |  |   |   | 50           | 150   | 250   | mV    |
| NEET On Desistance            | Б  | $V_{DD} = 5V, I = 0.5A$   |   |              | 0.04  | 0.07  | 0     |
| NFET On-Resistance            | R <sub>DS(ON-N)</sub>                      | V <sub>DD</sub> = 3V, I = 0.5A  |   |              | 0.06  | 0.08  | Ω     |
| PFET On-Resistance            | R <sub>DS</sub> (ON-P)                     | $\frac{V_{DD} = 5V, I = 0.5A}{V_{DD} = 3V, I = 0.5A}$   |   | 0.06<br>0.09 | 0.10  | Ω     |       |
|                               |  |   |   |              | 0.12  |       |       |
| NEET Lookogo                  | $V_{LX} = V_{DD} = 5V, T_A = +25^{\circ}C$ |   | 4 = +25°C                                 |              | 0.02  | 10    | μΑ    |
| NFET Leakage                  | ILEAK(N)                                   | V <sub>L</sub> X = V <sub>DD</sub> = 5V, T <sub>A</sub> = +85°C                                     |   |              | 1     |       |       |

# **Electrical Characteristics (continued)**

 $(V_{DD} = PV_{DD}1 = PV_{DD}2 = \overline{SHDN} = 5V, PGND1 = PGND2 = FREQ = GND, CTLI = MAXV = MAXIP = MAXIN = REF, C_{REF} = 1\mu F, C_{COMP} = 0.01\mu F, L_{LX} = 3.3\mu H, C_{CS} = C_{OS2} = 1\mu F, I_{TEC} < 3A_{RMS} (MAX1968), I_{TEC} < 6A_{RMS} (MAX1969), T_{A} = 0^{\circ}C to +85^{\circ}C, unless otherwise noted. Typical values are at T_{A} = +25^{\circ}C.)$ 

| PARAMETER                                  | SYMBOL   | CONDITIONS   | MIN                       | TYP  | MAX                       | UNITS |
|--|--|--|---------------------------|------|---------------------------|-------|
|  |  | $V_{LX} = 0$ , $T_A = +25^{\circ}C$  |                           | 0.02 | 10                        |       |
| PFET Leakage                               | ILEAK(P)   | $V_{LX} = 0$ , $T_A = +85^{\circ}C$  |                           | 1    |                           | μΑ    |
| No Load Supply                             | I <sub>DD</sub>  | V <sub>DD</sub> = 5V   |                           | 32   | 100                       |       |
| Current                                    | (NO LOAD)  | V <sub>DD</sub> = 3.3V   |                           | 20   | 30                        | mA    |
| Shutdown Supply<br>Current                 | I <sub>DD-SD</sub>                                       | V <sub>DD</sub> = 5V (Note 2)  |                           | 2    | 3                         | mA    |
| Thermal Shutdown                           | T <sub>SHUTDOWN</sub>                                    | Hysteresis = 15°C  |                           | +165 |                           | °C    |
| UVLO Threshold                             | V <sub>UVLO</sub>  | V <sub>DD</sub> rising   | 2.4                       | 2.6  | 2.8                       | V     |
| OVEO TITESTICIO                            | VUVLO  | V <sub>DD</sub> falling  | 2.25                      | 2.5  | 2.75                      | V     |
| Switching Frequency<br>Internal Oscillator | fsw-INT  | FREQ = GND   | 400                       | 550  | 650                       | kHz   |
| OS1, OS2, CS Input<br>Current              | I <sub>OS1</sub> ,<br>I <sub>OS2</sub> , I <sub>CS</sub> | 0 or V <sub>DD</sub>   | -100                      |      | +100                      | μΑ    |
| SHDN, FREQ Input<br>Current                | I <del>SHDN</del> ,<br>IFREQ                             | 0 or V <sub>DD</sub>   | -5                        |      | +5                        | μΑ    |
| SHDN, FREQ Input<br>Low Voltage            | VIL  | V <sub>DD</sub> = 3V to 5.5V   |                           |      | V <sub>DD</sub> x<br>0.25 | V     |
| SHDN, FREQ Input<br>High Voltage           | V <sub>IH</sub>  | V <sub>DD</sub> = 3V to 5.5V   | V <sub>DD</sub> x<br>0.75 |      |                           | V     |
| MAXV Threshold                             |  | $V_{MAXV} = V_{REF} \times 0.67$ , $V_{OS1}$ to $V_{OS2} = \pm 4V$ , $V_{DD} = 5V$ | -2                        |      | +2                        | %     |
| Accuracy                                   |  | $V_{MAXV} = V_{REF} \times 0.33$ , $V_{OS1}$ to $V_{OS2} = \pm 2V$ , $V_{DD} = 3V$ | -2                        |      | +2                        | %     |
| MAXV, MAXIP, MAXIN<br>Input Bias Current   | IMAXV-BIAS,<br>IMAXIBIAS                                 | $V_{MAXV} = V_{MAXI} = 0.1V \text{ or } 1.5V$                                      | -0.1                      |      | +0.1                      | μΑ    |
| CTLI Gain Accuracy                         | A <sub>CTLI</sub>  | V <sub>CTLI</sub> = 0.5V to 2.5V (Note 3)  | 9.5                       | 10   | 10.5                      | V/V   |
| CTLI Input Resistance                      | RCTLI  | $1M\Omega$ terminated at REF   | 0.5                       | 1.0  | 2.0                       | МΩ    |
| Error-Amp<br>Transconductance              | Яm   |  | 50                        | 100  | 175                       | μΑ/V  |
| ITEC Accuracy                              |  | $V_{OS1}$ to $V_{CS} = +100$ mV or $-100$ mV                                       | -10                       |      | +10                       | %     |
| ITEC Load Regulation                       | ΔVITEC   | $V_{OS1}$ to $V_{CS}$ = +100mV or -100mV, $I_{ITEC}$ = $\pm$ 10 $\mu$ A            | -0.1                      |      | +0.1                      | %     |

### **Electrical Characteristics**

 $(V_{DD} = PV_{DD}1 = PV_{DD}2 = \overline{SHDN} = 5V, \ PGND1 = PGND2 = FREQ = GND, \ CTLI = MAXV = MAXIP = MAXIN = REF, \ C_{REF} = 1\mu F, \ C_{COMP} = 0.1\mu F, \ L_{LX} = 3.3\mu H, \ C_{CS} = C_{OS2} = 1\mu F, \ I_{TEC} < 3A_{RMS} \ (MAX1968), \ I_{TEC} < 6A_{RMS} \ (MAX1969), \ T_{A} = -40^{\circ}C \ to +85^{\circ}C, \ unless otherwise noted.) \ (Note 4)$ 

| PARAMETER                                  | SYMBOL                 | CONDITIONS   |  | MIN   | TYP      | MAX   | UNITS |
|--|------------------------|--|--|-------|----------|-------|-------|
| Input Supply Range                         | $V_{\mathrm{DD}}$      |  |  | 3.0   |          | 5.5   | V     |
|  |                        | $V_{DD} = 5V$ , $I_{TEC} = 0$ to $V_{OUT} = V_{OS1} - V_{OS2}$ (I  |  | -4.3  | -4.3 +4. | +4.3  |       |
| Outrout Voltage Denge                      | V                      | $V_{DD} = 5V$ , $I_{TEC} = 0$ to $V_{OUT} = V_{OS1}$ (MAX19)   |  |       |          | 4.3   | V     |
| Output Voltage Range                       | Vout                   | V <sub>DD</sub> = 3V, I <sub>TEC</sub> = 0 to<br>V <sub>OUT</sub> = V <sub>OS1</sub> - V <sub>OS2</sub> (I | *  | -2.3  |          | +2.3  | V     |
|  |                        | V <sub>DD</sub> = 3V, I <sub>TEC</sub> = 0 to<br>V <sub>OUT</sub> = V <sub>OS1</sub> (MAX19)               |  |       |          | 2.3   |       |
| Maximum TEC                                | l==0.4400              | MAX1968  |  |       |          | ±3    | А     |
| Current                                    | ITEC(MAX)              | MAX1969  |  |       |          | 6     | A     |
| Reference Voltage                          | V <sub>REF</sub>       | $V_{DD} = 3V \text{ to 5.5V, } I_{REF}$  | = 150μΑ                                    | 1.475 |          | 1.515 | V     |
| Reference Load<br>Regulation               | ΔV <sub>REF</sub>      | $V_{DD} = 3V \text{ to 5.5V, I}_{REF}$   | = +10µA to -1mA                            |       |          | 5     | mV    |
|  |                        | VV   | V <sub>MAXI</sub> _ = V <sub>REF</sub>     | 135   |          | 165   |       |
| Current-Sense<br>Threshold Accuracy        |                        | Vos1 < Vcs   | V <sub>MAXI</sub> _ = V <sub>REF</sub> / 3 | 35    |          | 65    | mV    |
|  |                        | Vost > Vcs   | $V_{MAXI} = V_{REF}$                       | 135   |          | 165   |       |
|  |                        | VUST > VCS   | V <sub>MAXI</sub> _ = V <sub>REF</sub> / 3 | 35    |          | 65    |       |
| Switch-Fault Reset<br>Voltage              |                        |  |  | 50    |          | 250   | mV    |
| NEET On Desistance                         | D                      | V <sub>DD</sub> = 5V, I = 0.5A   |  |       |          | 0.07  | 0     |
| NFET On-Resistance                         | R <sub>DS</sub> (ON-N) | V <sub>DD</sub> = 3V, I = 0.5A   |  |       |          | 0.08  | Ω     |
| PFET On-Resistance                         | Descens                | $V_{DD} = 5V, I = 0.5A$  |  |       |          | 0.07  | Ω     |
| PPET Off-nesistance                        | RDS(ON-P)              | $V_{DD} = 3V, I = 0.5A$  |  |       |          | 0.12  |       |
| NFET Leakage                               | 1                      | $V_{LX} = V_{DD} = 5V, T_A =$  | +25°C                                      |       |          | 10    | μΑ    |
| 111 L1 Leanage                             | ILEAK(N)               | $V_{LX} = V_{DD} = 5V, T_A =$  | -40°C                                      |       |          | 10    | μΛ    |
| PFET Leakage                               | I <sub>LEAK(P)</sub>   | $V_{LX} = 0, T_A = +25^{\circ}C$   |  |       |          | 10    | μΑ    |
| 11 L1 Leakage                              | ILEAN(P)               | $V_{LX} = 0, T_A = -40^{\circ}C$   |  |       |          | 10    | μΛ    |
| No Load Supply                             | I <sub>DD(NO</sub>     | $I_{DD(NO}$ $V_{DD} = 5V$  |  |       |          | 100   | mA    |
| Current                                    | LOAD)                  | $V_{DD} = 3.3V$  |  |       | 30       |       | 11.0  |
| Shutdown Supply<br>Current                 | I <sub>DD-SD</sub>     | SHDN = GND, V <sub>DD</sub> = 5V (Note 2)  |  |       |          | 3     | mA    |
| IIVI O Throshold                           | a alal                 | V <sub>DD</sub> rising V <sub>DD</sub> falling   |  | 2.4   |          | 2.8   | V     |
| UVLO Threshold                             | V <sub>U</sub> VLO     |  |  | 2.25  |          | 2.75  | V     |
| Switching-Frequency<br>Internal Oscillator | f <sub>SW-INT</sub>    | FREQ = GND   |  | 400   |          | 650   | kHz   |

# **Electrical Characteristics (continued)**

 $(V_{DD} = PV_{DD}1 = PV_{DD}2 = \overline{SHDN} = 5V, \ PGND1 = PGND2 = FREQ = GND, \ CTLI = MAXV = MAXIP = MAXIN = REF, \ C_{REF} = 1\mu F, \ C_{COMP} = 0.01\mu F, \ L_{LX} = 3.3\mu H, \ C_{CS} = C_{OS2} = 1\mu F, \ I_{TEC} < 3A_{RMS} \ (MAX1968), \ I_{TEC} < 6A_{RMS} \ (MAX1969), \ T_A = -40^{\circ}C \ to +85^{\circ}C, \ unless otherwise noted.) (Note 4)$ 

| PARAMETER                                | SYMBOL  | CONDITIONS   | MIN                       | TYP | MAX                       | UNITS |
|--|---|--|---------------------------|-----|---------------------------|-------|
| OS1, OS2, CS Input<br>Current            | los <sub>1</sub> ,<br>los <sub>2</sub> , los      | 0 or V <sub>DD</sub>   | -100                      |     | +100                      | μΑ    |
| SHDN, FREQ Input<br>Current              | ISHDN,<br>IFREQ                                   | 0 or V <sub>DD</sub>   | -5                        |     | +5                        | μΑ    |
| SHDN, FREQ Input<br>Low Voltage          | VIL   | V <sub>DD</sub> = 3V to 5.5V   |                           |     | V <sub>DD</sub> x<br>0.25 | V     |
| SHDN, FREQ Input<br>High Voltage         | VIH   | V <sub>DD</sub> = 3V to 5.5V   | V <sub>DD</sub> x<br>0.75 |     |                           | V     |
| MAXV Threshold                           |   | $V_{MAXV} = V_{REF} \times 0.67$ , $V_{OS1}$ to $V_{OS2} = \pm 4V$ , $V_{DD} = 5V$ | -2 +2                     | +2  | %                         |       |
| Accuracy                                 |   | $V_{MAXV}$ = $V_{REF}$ x 0.33, $V_{OS1}$ to $V_{OS2}$ = $\pm 2V$ , $V_{DD}$ = $3V$ | -2                        |     | +2                        | 76    |
| MAXV, MAXIP, MAXIN<br>Input Bias Current | I <sub>MAXV-BIAS</sub> ,<br>I <sub>MAXIBIAS</sub> | $V_{MAXV} = V_{MAXI} = 0.1V \text{ or } 1.5V$                                      | -0.1                      |     | +0.1                      | μΑ    |
| CTLI Gain Accuracy                       | ACTLI   | V <sub>CTLI</sub> = 0.5V to 2.5V (Note 3)  | 9.5                       |     | 10.5                      | V/V   |
| CTLI Input Resistance                    | RCTLI   | 1MΩ terminated at REF  | 0.5                       | •   | 2.0                       | MΩ    |
| Error-Amp<br>Transconductance            | gm  |  | 50                        |     | 175                       | μΑ/V  |
| ITEC Accuracy                            |   | $V_{OS1}$ to $V_{CS} = +100$ mV or $-100$ mV                                       | -10                       |     | +10                       | %     |

Note 2: Includes power FET leakage.

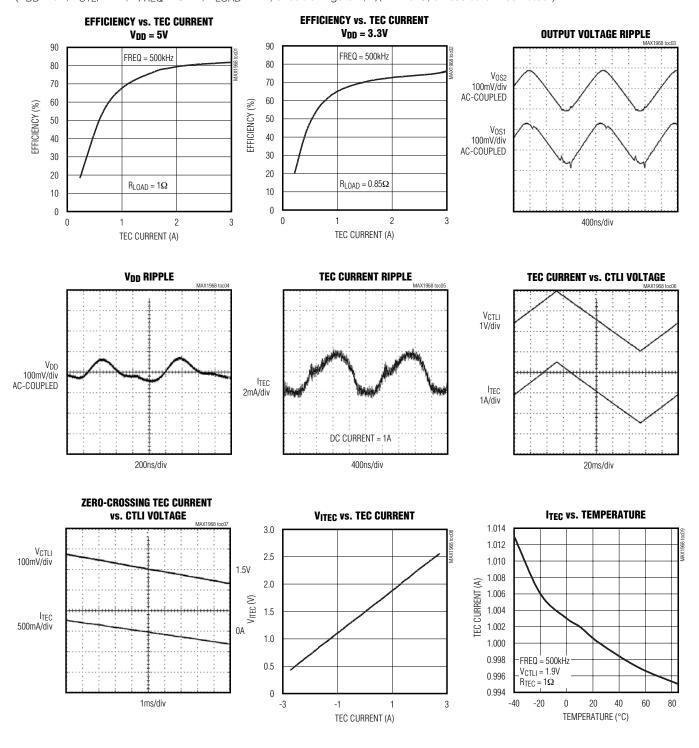
Note 3: CTLI Gain is defined as:

$$\mathsf{A}_{\mathsf{CTLI}} = \frac{(\mathsf{V}_{\mathsf{CTLI}} - \mathsf{V}_{\mathsf{REF}})}{\mathsf{V}_{\mathsf{OS1}} - \mathsf{V}_{\mathsf{CS}}}$$

Note 4: Specifications to -40°C are guaranteed by design, not production tested.

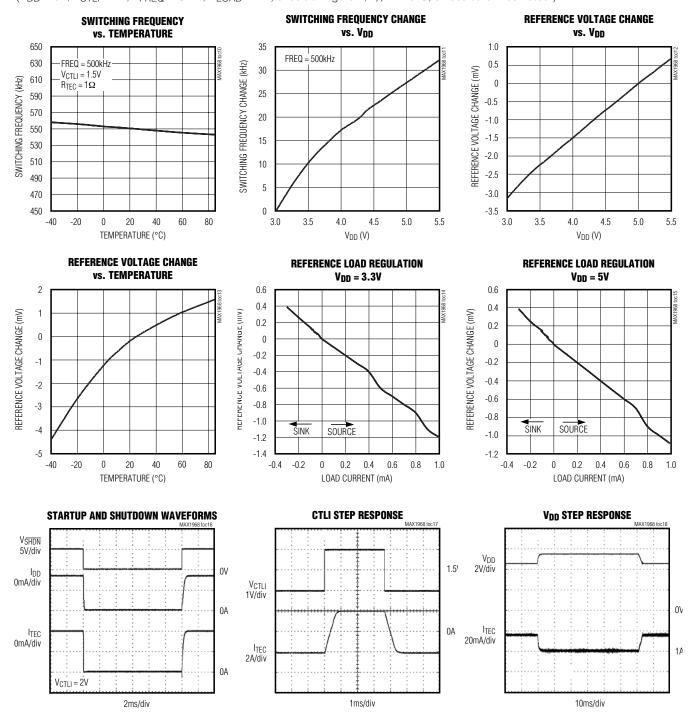
### **Typical Operating Characteristics**

 $(V_{DD} = 5V, V_{CTLI} = 1V, V_{FREQ} = GND, R_{LOAD} = 1\Omega$ , circuit of Figure 1,  $T_{A} = +25^{\circ}C$ , unless otherwise noted.)



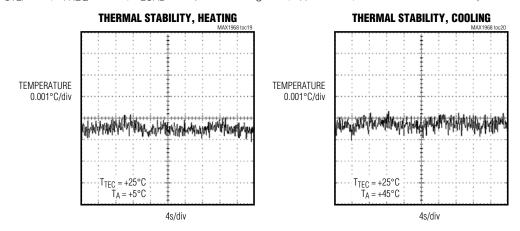
### **Typical Operating Characteristics (continued)**

 $(V_{DD} = 5V, V_{CTLI} = 1V, V_{FREQ} = GND, R_{LOAD} = 1\Omega$ , circuit of Figure 1,  $T_{A} = +25^{\circ}C$ , unless otherwise noted.)

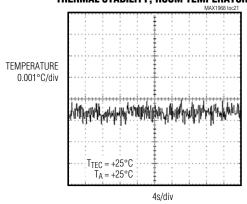


### **Typical Operating Characteristics (continued)**

 $(V_{DD} = 5V, V_{CTLI} = 1V, V_{FREQ} = GND, R_{LOAD} = 1\Omega$ , circuit of Figure 1,  $T_{A} = +25$ °C, unless otherwise noted.)



#### THERMAL STABILITY, ROOM TEMPERATURE

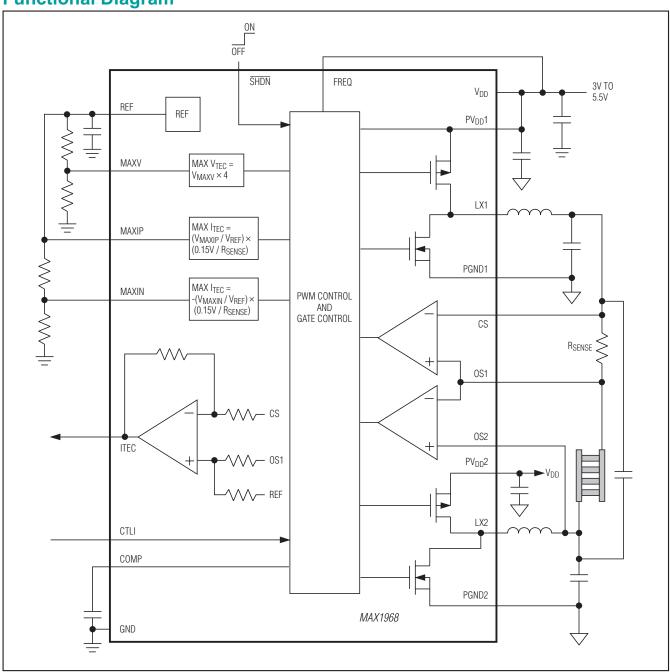


# Power Drivers for Peltier TEC Modules

# **Pin Description**

| PIN        | NAME               | FUNCTION  |
|------------|--------------------|---|
| 1          | V <sub>DD</sub>    | Analog Supply Voltage Input   |
| 2          | GND                | Analog Ground   |
| 3          | CTLI               | TEC Current Control Input. Sets differential current into the TEC. Center point is 1.50V (no TEC current). The current is given by:  ITEC = (VOS1 - VCS) / RSENSE = (VCTLI - 1.50) / (10 x RSENSE). When (VCTLI - VREF) > 0, VOS2 > VOS1 > VCS. |
| 4          | REF                | 1.50V Reference Output. Bypass REF to GND with a 1µF ceramic capacitor.   |
| 5, 7       | PGND2              | Power Ground 2. Internal synchronous rectifier ground connections. Connect all PGND pins together at power ground plane.  |
| 6, 8, 10   | LX2                | Inductor Connection. Connect all LX2 pins together. For MAX1969, connect LX1 and LX2 pins together.   |
| 9, 11      | PV <sub>DD</sub> 2 | Power 2 Inputs. Must be same voltage as V <sub>DD</sub> . Connect all PV <sub>DD</sub> 2 inputs together at the V <sub>DD</sub> power plane.  |
| 12         | FREQ               | Switching Frequency Select. High = 1MHz, Low = 500kHz.  |
| 13         | ITEC               | TEC Current Monitor Output. The ITEC output voltage is a function of the voltage across the TEC current-<br>sense resistor. V <sub>ITEC</sub> = 1.50V + (V <sub>OS1</sub> - V <sub>CS</sub> ) x 8.  |
| 14         | OS2                | Output Sense 2. OS2 senses one side of the differential TEC voltage. OS2 is a sense point, not a power output. For MAX1969, connect OS2 to GND.   |
| 15         | OS1                | Output Sense 1. OS1 senses one side of the differential TEC voltage. OS1 is a sense point, not a power output.  |
| 16         | CS                 | Current-Sense Input. The current through the TEC is monitored between CS and OS1. The maximum TEC current is given by 150mV / RSENSE and is bipolar.  |
| 17         | SHDN               | Shutdown Control Input. Active-low shutdown control.  |
| 18, 20     | PV <sub>DD</sub> 1 | Power 1 Inputs. Must be same voltage as V <sub>DD</sub> . Connect all PV <sub>DD</sub> 1 inputs together at the V <sub>DD</sub> power plane.  |
| 19, 21, 23 | LX1                | Inductor Connection. Connect all LX1 pins together. For MAX1969, connect all LX1 and LX2 pins together.   |
| 22, 24     | PGND1              | Power Ground 1. Internal synchronous rectifier ground connections. Connect all PGND pins together at power ground plane.  |
| 25         | COMP               | Current Control-Loop Compensation. For most designs connect a 0.01µF capacitor from COMP to GND.  |
| 26         | MAXIN              | Maximum Negative TEC Current. Connect MAXIN to REF to set default negative current limit -150mV / RSENSE. For MAX1969, connect MAXIN to MAXIP.  |
| 27         | MAXIP              | Maximum Positive TEC Current. Connect MAXIP to REF to set default positive current limit +150mV / RSENSE. (See the Setting Max Positive and Negative TEC Current section).  |
| 28         | MAXV               | Maximum Bipolar TEC Voltage. Connect an external resistive-divider from REF to GND to set the maximum voltage. The maximum TEC voltage is 4 x V <sub>MAXV</sub> .   |
| _          | EP                 | Exposed Pad. Internally connected to GND. Connect to a large ground plane to maximize thermal performance.  |

# **Functional Diagram**



### **Detailed Description**

The MAX1968/MAX1969 TEC drivers consist of two switching buck regulators that operate together to directly control TEC current. This configuration creates a differential voltage across the TEC, allowing bidirectional TEC current for controlled cooling and heating. Controlled cooling and heating allow accurate TEC temperature control within the tight tolerances of laser driver specifications. The voltage at CTLI directly sets the TEC current. An external thermal-control loop is typically used to drive CTLI. Figures 1 and 2 show examples of thermal control-loop circuits.

#### Ripple Cancellation

Switching regulators like those used in the MAX1968/MAX1969 inherently create ripple voltage on the output. The regulators in the MAX1968 switch in phase and provide complementary in-phase duty cycles so ripple waveforms at the TEC are greatly reduced. This feature suppresses ripple currents and electrical noise at the TEC to prevent interference with the laser diode.

#### Switching Frequency

FREQ sets the switching frequency of the internal oscillator. With FREQ = GND, the oscillator frequency is set to 500kHz. The oscillator frequency is 1MHz when FREQ = VDD.

#### **Voltage and Current-Limit Settings**

Both the MAX1968 and MAX1969 provide control of the maximum differential TEC voltage. Applying a voltage to MAXV limits the maximum voltage across the TEC. The MAX1968 provides control of the maximum positive and negative TEC current. The voltage at MAXIP and MAXIN sets the maximum positive and negative current through the TEC. These current limits can be independently controlled. The MAX1969 only controls TEC current in one direction. The maximum TEC current is controlled by MAXIP. Connect MAXIN to GND when using the MAX1969.

#### **Current Monitor Output**

ITEC provides a voltage output proportional to the TEC current (ITEC). See the *Functional Diagram* for more detail:

$$VITEC = 1.5V + 8 \times (VOS1 - VCS)$$

#### **Reference Output**

The MAX1968/MAX1969 include an on-chip voltage reference. The 1.50V reference is accurate to 1% over temperature. Bypass REF with 1µF to GND. REF may be used to bias an external thermistor for temperature sensing as shown in Figures 1 and 2.

### **Design Procedure**

#### **Inductor Selection**

Small surface-mount inductors are ideal for use with the MAX1968/MAX1969.  $3.3\mu H$  inductors are suitable for most applications. Select the output inductors so that the LC resonant frequency of the inductance and the output capacitance is less than 1/5 the selected switching frequency. For example,  $3.3\mu H$  and  $1\mu F$  have a resonance at 87.6kHz, which is adequate for 500kHz operation

$$f = \frac{1}{2\pi\sqrt{LC}}$$

where:

f = resonant frequency of output filter.

#### **Capacitor Selection**

#### **Filter Capacitors**

Decouple each power-supply input (VDD, PVDD1, PVDD2) with a 1µF ceramic capacitor close to the supply pins. In some applications with long distances between the source supply and the MAX1968/MAX1969, additional bypassing may be needed to stabilize the input supply. In such cases, a low-ESR electrolytic capacitor of 100µF or more at VDD is usually sufficient.

#### **Compensation Capacitor**

A compensation capacitor is needed to ensure current control-loop stability. Select the capacitor so that the unity-gain bandwidth of the current control loop is less than or equal to 1/12th the resonant frequency of the output filter:

$$C_{COMP} \ge \left(\frac{g_{m}}{f_{BW}}\right) \times \left(\frac{24 \times R_{SENSE}}{2\pi \times (R_{SENSE} + R_{TEC})}\right) \text{ (For MAX1968)}$$

$$C_{COMP} \ge \left(\frac{g_{m}}{f_{BW}}\right) \times \left(\frac{12 \times R_{SENSE}}{2\pi \times (R_{SENSE} + R_{TEC})}\right) \text{ (For MAX1969)}$$

where:

fBW = loop unity gain bandwidth

gm = loop transconductance, typically 100µA/V

CCOMP = value of the compensation capacitor

RTEC = TEC series resistance

Rsense = sense resistor

### Power Drivers for Peltier TEC Modules

#### **Setting Voltage and Current Limits**

Certain TEC parameters must be considered to guarantee a robust design. These include maximum positive current, maximum negative current, and the maximum voltage allowed across the TEC. These limits should be used to set the MAXIP, MAXIN, and MAXV voltages.

# Setting Max Positive and Negative TEC Current

MAXIP and MAXIN set the maximum positive and negative TEC currents, respectively. The default current limit is  $\pm 150 \text{mV}$  / RSENSE when MAXIP and MAXIN are connected to REF. To set maximum limits other than the defaults, connect a resistor-divider from REF to GND to set VMAXI\_. Use resistors in the  $10 \text{k}\Omega$  to  $100 \text{k}\Omega$  range. VMAXI\_ is related to ITEC by the following equations:

VMAXIP = 10(ITECP(MAX) x RSENSE)

VMAXIN = 10(ITECN(MAX) x RSENSE)

where ITECP(MAX) is the maximum positive TEC current and ITECN(MAX) is the negative maximum TEC current.

Positive TEC current occurs when CS is less than OS1:

ITEC x RSENSE = VOS1 - VCS

when ITEC > 0.

ITEC x RSENSE = VCS - VOS1

when ITFC < 0.

The MAX1969 controls the TEC current in one direction (unipolar current flow from OS1 to CS). Set the maximum unipolar TEC current by applying a voltage to MAXIN. Connect MAXIP to MAXIN. The equation for setting MAXIN is the same for the MAX1968 and MAX1969.

Take care not to exceed the positive or negative current limit on the TEC. Refer to the manufacturer's data sheet for these limits.

#### **Setting MAX TEC Voltage**

Apply a voltage to the MAXV pin to control the maximum differential TEC voltage. MAXV can vary from 0 to REF. The voltage across the TEC is four times  $V_{MAXV}$  and can be positive or negative:

 $IVOS1 - VOS2I = 4 \times VMAXV$ 

Set  $V_{MAXV}$  with a resistor-divider between REF and GND using resistors from  $10k\Omega$  to  $100k\Omega$ .  $V_{MAXV}$  can vary from 0 to REF.

#### **Control Inputs/Outputs**

#### **Output Current Control**

The voltage at CTLI directly sets the TEC current. CTLI is typically driven from the output of a temperature control loop. For the purposes of the following equations, it is assumed that positive TEC current is cooling (see Figure 1). The transfer function relating current through the TEC (ITEC) and VCTLI is given by:

ITEC = (VCTLI - VREF)/(10 x RSENSE)

where VREF is 1.50V and:

ITEC = (Vos1 - Vcs)/Rsense

CTLI is centered around REF (1.50V). I<sub>TEC</sub> is zero when CTLI = 1.50V. When VCTLI > 1.50V the MAX1968 is cooling. Current flow is from OS2 to OS1. The voltages on the pins relate as follows:

Vos2 > Vos1 > Vcs

The opposite applies when heating. When VCTLI < 1.50V current flows from OS1 to OS2:

Vos2 < Vos1 < Vcs

#### **Shutdown Control**

The MAX1968/MAX1969 can be placed in a power-saving shutdown mode by driving  $\overline{SHDN}$  low. When the MAX1968/MAX1969 are shut down, the TEC is off (OS1 and OS2 decay to GND) and supply current is reduced to 2mA (typ).

#### **ITEC Output**

ITEC is a status output that provides a voltage proportional to the actual TEC current. ITEC = REF when TEC current is zero. The transfer function for the ITEC output is:

 $VITEC = 1.50 + 8 \times (VOS1 - VCS)$ 

Use ITEC to monitor the cooling or heating current through the TEC. The maximum capacitance that ITEC can drive is 100pF.

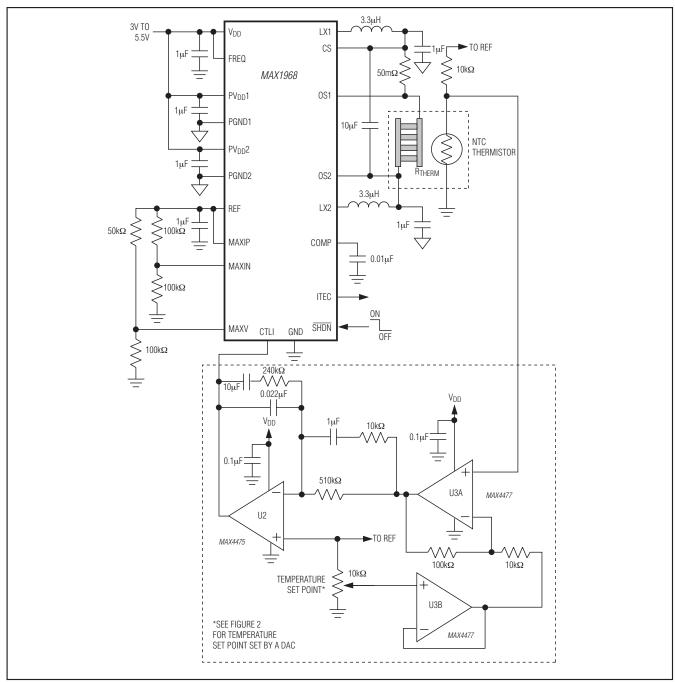


Figure 1. Typical Application Circuit for MAX1968. Circuit is configured for both cooling and heating with an NTC thermistor. Current flowing from OS2 to OS1 is cooling.

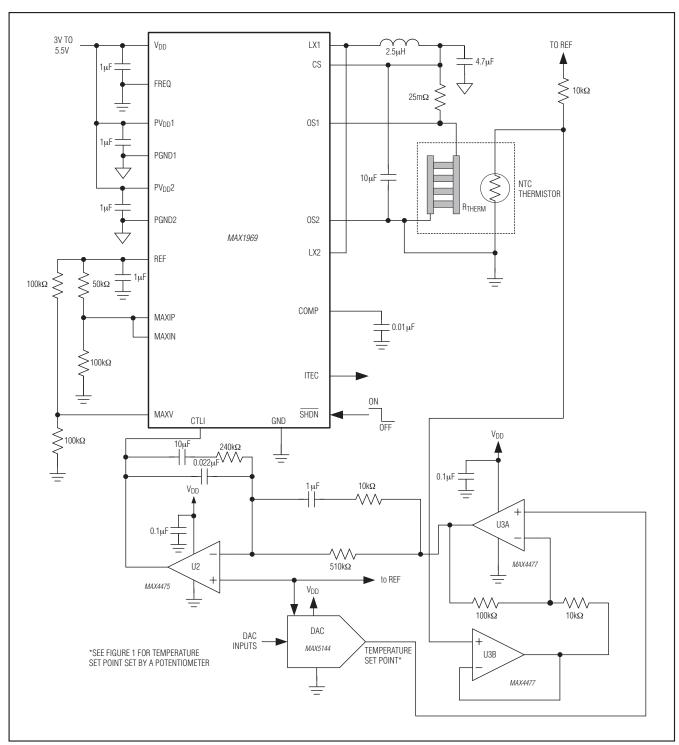


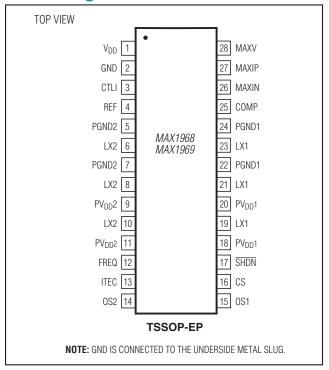
Figure 2. Typical Application Circuit for MAX1969. MAXIN sets the maximum TEC current. Circuit configured for cooling with NTC thermistor. Current always flows from CS to OS2.

# **Applications Information**

The MAX1968/MAX1969 typically drive a thermoelectric cooler inside a thermal control loop. TEC drive polarity and power are regulated based on temperature information read from a thermistor, or other temperaturemeasuring device to maintain a stable control temperature. Temperature stability of 0.01°C can be achieved with carefully selected external components.

There are numerous ways to implement the thermal loop. Figures 1 and 2 show a design that employs precision op amps, along with a DAC or potentiometer to set the control temperature. The loop may also be implemented digitally, using a precision A/D to read the thermistor or other temperature sensor, a microcontroller to implement the control algorithm, and a DAC (or filtered PWM signal) to send the appropriate signal to the MAX1968/MAX1969 CTLI input. Regardless of the form taken by the thermal control circuitry, all designs are similar in that they read temperature, compare it to a set-point signal, and then send an error-correcting signal to the MAX1968/MAX1969 that moves the temperature in the appropriate direction.

### **Pin Configuration**



# **Chip Information**

**TRANSISTOR COUNT: 2959** 

PROCESS: BICMOS

# **Package Information**

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

| PACKAGE  | PACKAGE | OUTLINE        | LAND           |
|----------|---------|----------------|----------------|
| TYPE     | CODE    | NO.            | PATTERN NO.    |
| 28 TSSOP | U28E4   | <u>21-0108</u> | <u>90-0146</u> |

### Power Drivers for Peltier TEC Modules

# **Revision History**

| REVISION | REVISION | DESCRIPTION                           | PAGES   |
|----------|----------|---------------------------------------|---------|
| NUMBER   | DATE     |                                       | CHANGED |
| 3        | 5/15     | Updated Benefits and Features section | 1       |

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